TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π -MOSVI)

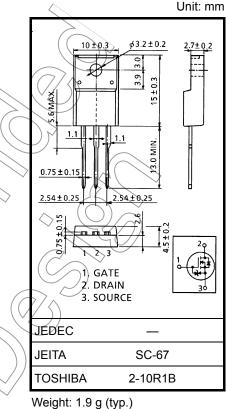
2SK4106

Switching Regulator Applications

Low drain-source ON resistance: R_{DS} (ON) = 0.4 Ω (typ.)

- High forward transfer admittance: |Y_{fs}| = 8.5 S (typ.)
- Low leakage current: $I_{DSS} = 100 \ \mu A (max) (V_{DS} = 500 \ V)$
- Enhancement mode: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C) Characteristics Symbol Rating Unit Drain-source voltage VDSS 500 Ń Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$) 500 ¥ VDGR Ń Gate-source voltage VGSS ±3/0 42 DC (Note 1) I_D Drain current A Pulse (t = 1 ms) IDP 48 (Note 1) Drain power dissipation (Tc = 25°C) 45 ₩ P_D Single pulse avalanche energy 364 Eaş шJ (Note 2) А Avalanche current 12 IAR Repetitive avalanche energy (Note 3) EAR 4 mJ ç Channel temperature Tch 150 °Č Storage temperature range -55 to 150 ∕T_{stg}



Note: Using continuously under heavy loads (e.g. the application of fligh temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	Rth (ch-c)	2.78	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: $V_{DD} = 90 \text{ V}, \text{ T}_{ch} = 25^{\circ}\text{C}(\text{initial}), \text{ L} = 4.3 \text{ mH}, \text{ I}_{AR} = 12 \text{ A}, \text{ R}_{G} = 25 \Omega$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.

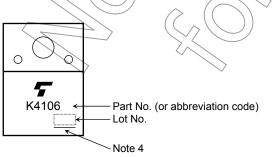
Electrical Characteristics (Ta = 25°C)

Char	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cui	rent	I _{GSS}	$V_{GS}=\pm 25~V,~V_{DS}=0~V$	_		±10	μA
Gate-source brea	akdown voltage	V (BR) GSS	$I_G=\pm 10~\mu A,~V_{DS}=0~V$	±30	_		V
Drain cut-off curr	ent	I _{DSS}	$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		_	100	μA
Drain-source bre	akdown voltage	V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	500			V
Gate threshold ve	oltage	V _{th}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$	2.0)~	4.0	V
Drain-source ON	resistance	R _{DS (ON)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 6 \text{ A}$		0.4	0.52	Ω
Forward transfer	admittance	Y _{fs}	$V_{DS} = 10 V, I_D = 6 A$	3.5	8.5		S
Input capacitance	9	C _{iss}			1500		
Reverse transfer	capacitance	C _{rss}	$V_{DS} = 25 V$, $V_{GS} = 0 V$, f = 1 MHz		15		pF
Output capacitance		C _{oss}			180		
Switching time	Rise time	tr	V_{GS}		22	>	
	Turn-on time	t _{on}	$\begin{array}{c} 0 \\ 0 \\ 50 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 $		50) —	20
	Fall time	t _f	$\begin{array}{c} 0.0012\\$		36		ns
	Turn-off time	t _{off}	Duty \leq 1%, t _W = 10 μ s	\mathbb{R}	170		
Total gate charge	9	Qg) —	42		
Gate-source charge Q _{gs}		Q _{gs}	$V_{DD} \simeq 400 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 12 \text{ A}$		23		nC
Gate-drain charge Qgd		Qgd			19		

Source-Drain Ratings and Characteristics (Ta = 25°C)

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Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)			_	_	12	А
Pulse drain reverse current (Note 1)	IDRP	<u> </u>	_	_	48	Α
Forward voltage (diode)	VDSF	I _{DR} = 12 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	trr	I _{DR} = 12 A, V _{GS} = 0 V,	_	1200	_	ns
Reverse recovery charge	Q _{rr}	dl _{DR} /dt = 100 A/µs	_	16		μC

Marking

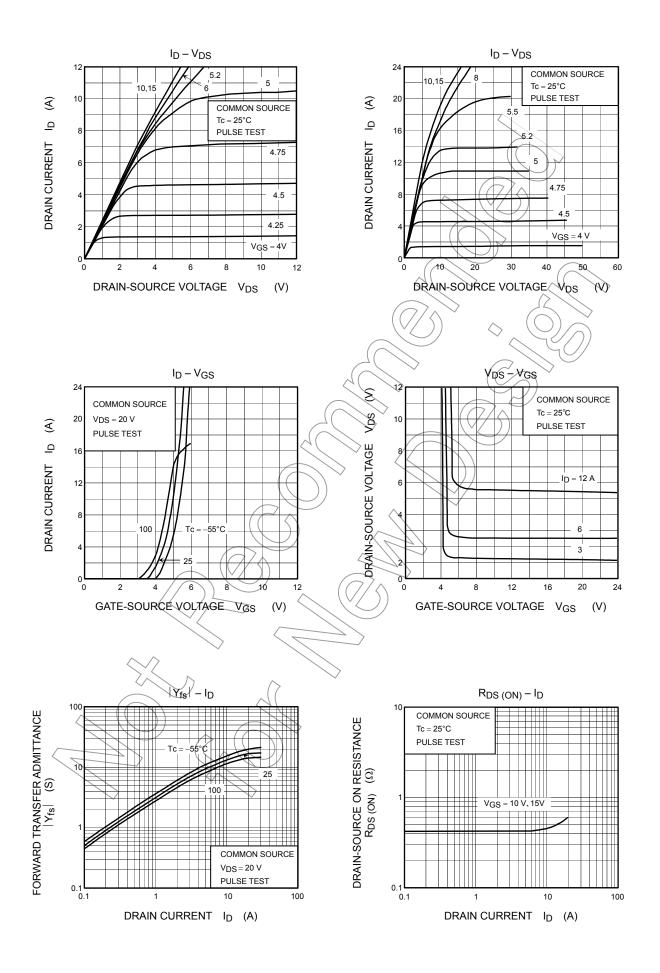


Note 4: A line under a Lot No. identifies the indication of product Labels.

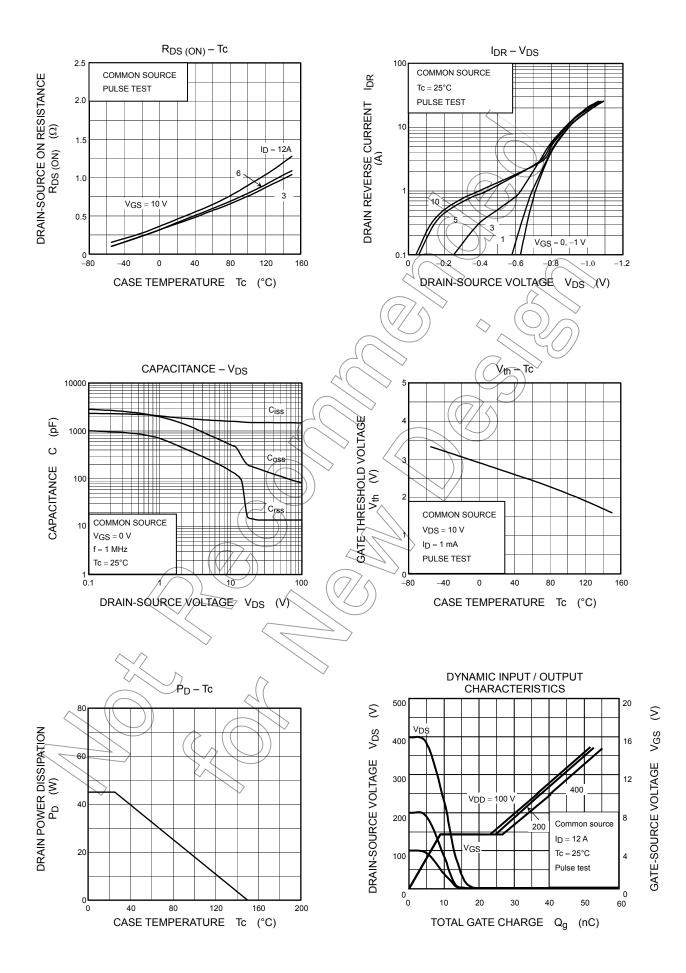
Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

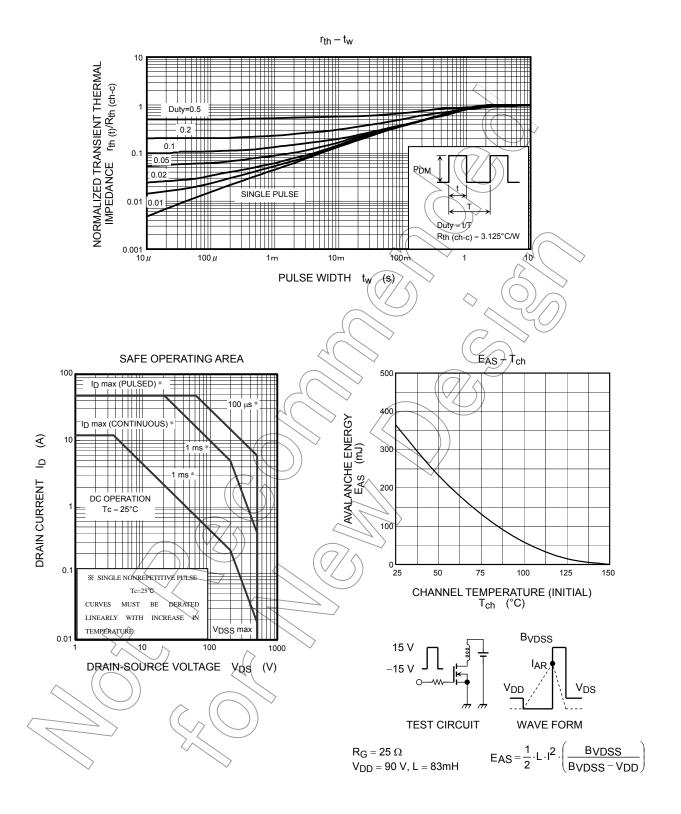
Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

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